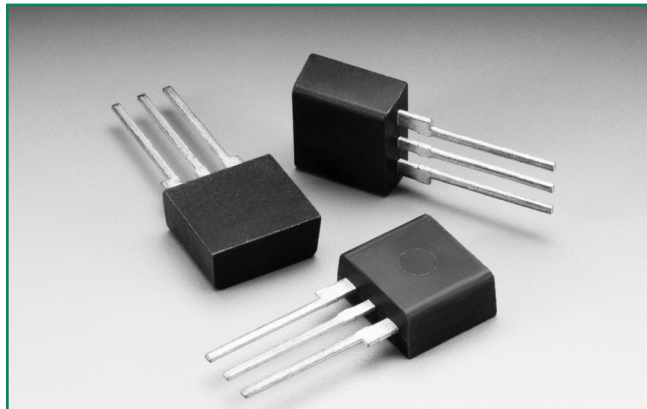


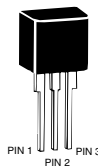
Balanced MC Series - Modified TO-220



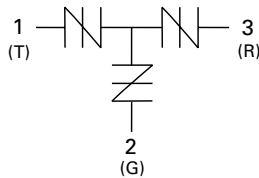
Agency Approvals

| Agency | Agency File Number |
|--------|--------------------|
| | E133083 |

Pinout Designation



Schematic Symbol



Description

Balanced MC Series Modified TO-220 are low capacitance SIDACtor® components designed to protect broadband equipment from damaging overvoltage transients. The patented “Y” configuration also ensures balanced overvoltage protection that prevents a longitudinal to differential conversion.

The series provides a single port solution that enables equipment to comply with various global regulatory standards while limiting the impact to broadband signals.

Features and Benefits

- Low voltage overshoot
- Low on-state voltage
- Does not degrade surge capability after multiple surge events within limit.
- Fails short circuit when surged in excess of ratings
- Balanced overvoltage protection
- RoHS Compliant, Lead-Free, and Halogen-Free
- 40% lower capacitance
- than our Baseband Protectors, for applications that demand greater signal integrity
- Robust Modified TO-220 Package
- Custom lead forms available
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Applicable Global Standards

- TIA-968-A
- TIA-968-B
- ITU K.20/21/45 Enhanced Level
- ITU K.20/21/45 Basic
- GR 1089 Intra-building
- IEC 61000-4-5
- YD/T 1082
- YD/T 993
- YD/T 950

Electrical Characteristics

| Part Number | Marking | V_{DRM} @ $I_{DRM} = 5\mu A$ | V_S @ 100V/ μs | I_H | I_S | I_T | V_T @ $I_T = 2.2$ Amps | Capacitance |
|--------------|-----------|-----------------------------------|--------------------------|--------------------|--------|-------|-----------------------------|------------------------------|
| | | V min | V max | mA max | mA max | A max | V min | |
| | | Pins 1-2, 3-2, 1-3 | | Pins 1-2, 3-2, 1-3 | | | | |
| P1553ACMCLxx | P1553ACMC | 130 | 180 | 150 | 800 | 2.2 | 8 | See Capacitance Values Table |
| P1803ACMCLxx | P1803ACMC | 150 | 210 | 150 | 800 | 2.2 | 8 | |
| P2103ACMCLxx | P2103ACMC | 170 | 250 | 150 | 800 | 2.2 | 8 | |
| P2353ACMCLxx | P2353ACMC | 200 | 270 | 150 | 800 | 2.2 | 8 | |
| P2703ACMCLxx | P2703ACMC | 230 | 300 | 150 | 800 | 2.2 | 8 | |
| P3203ACMCLxx | P3203ACMC | 270 | 350 | 150 | 800 | 2.2 | 8 | |
| P3403ACMCLxx | P3403ACMC | 300 | 400 | 150 | 800 | 2.2 | 8 | |
| P5103ACMCLxx | P5103ACMC | 420 | 600 | 150 | 800 | 2.2 | 8 | |

Notes:
 - Absolute maximum ratings measured at $T_a = 25^\circ C$ (unless otherwise noted).
 - Components are bi-directional (unless otherwise noted).
 - **XX** Part Number Suffix: '**RP**' (Reel Pack), '**Blank**' (Bulk Pack), or '**60**' (Type 60 lead form, Bulk Pack. Special order item – contact factory.)

Capacitance Values

| Part Number | pF Pin 1-2 / 3-2 Tip-Ground, Ring-Ground | | pF Pin 1-3 Tip-Ring | |
|--------------|--|-----|---------------------------|-----|
| | MIN | MAX | MIN | MAX |
| P1553ACMCLxx | 30 | 55 | 20 | 35 |
| P1803ACMCLxx | 30 | 60 | 15 | 30 |
| P2103ACMCLxx | 30 | 45 | 15 | 30 |
| P2353ACMCLxx | 25 | 45 | 15 | 30 |
| P2703ACMCLxx | 25 | 40 | 15 | 30 |
| P3203ACMCLxx | 25 | 40 | 15 | 30 |
| P3403ACMCLxx | 20 | 35 | 15 | 25 |
| P5103ACMCLxx | 20 | 30 | 10 | 20 |

Note: Off-state capacitance (C_o) is measured at 1 MHz with a 2 V bias.

Surge Ratings

| Series | I_{PP} | | | | | | | | | | I_{TSM} 50/60 Hz | di/dt | |
|--------|--|--|--|--|--|--|--|--|---|-------|-----------------------|-------|----------|
| | 0.2/310 ¹ 0.5/700 ² | 2x/0 ¹ 2/10 ² | 8/20 ¹ 1.2/50 ² | 10/160 ¹ 10/160 ² | 10/560 ¹ 10/560 ² | 5/320 ¹ 9/720 ² | 10/360 ¹ 10/360 ² | 10/1000 ¹ 10/1000 ² | 5/310 ¹ 10/700 ² | A min | | | A/μs max |
| | A min | A min | A min | A min | A min | A min | A min | A min | A min | A min | | | A/μs max |
| C | 50 | 500 | 400 | 200 | 150 | 200 | 175 | 100 | 200 | 30 | 500 | | |

Notes:

1 Current waveform in μs

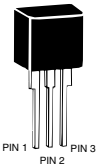
2 Voltage waveform in μs

- Peak pulse current rating (I_{pp}) is repetitive and guaranteed for the life of the product that remains in thermal equilibrium.

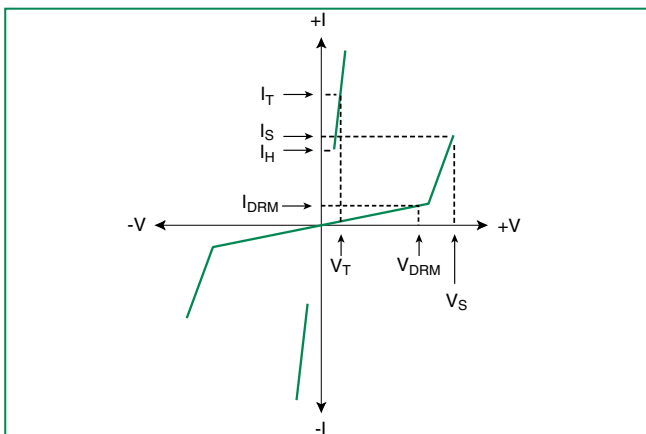
- I_{pp} ratings applicable over temperature range of -40°C to +85°C

- The component must initially be in thermal equilibrium with -40°C ≤ T_J ≤ +150°C

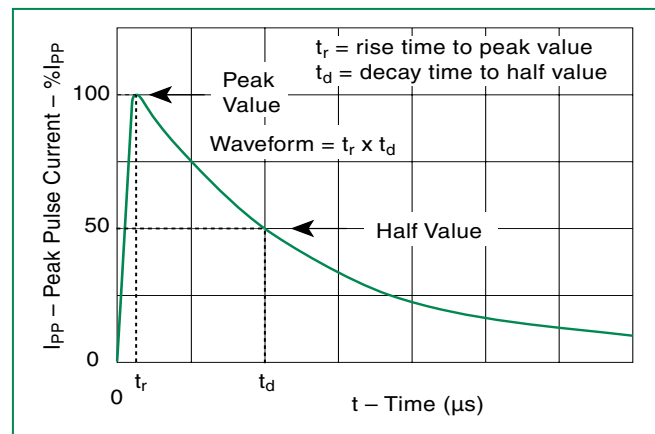
Thermal Considerations

| Package | Symbol | Parameter | Value | Unit |
|--|-----------------|---|-------------|------|
| Modified TO-220  | T_J | Operating Junction Temperature Range | -40 to +150 | °C |
| | T_S | Storage Temperature Range | -65 to +150 | °C |
| | $R_{\theta JA}$ | Thermal Resistance: Junction to Ambient | 50 | °C/W |

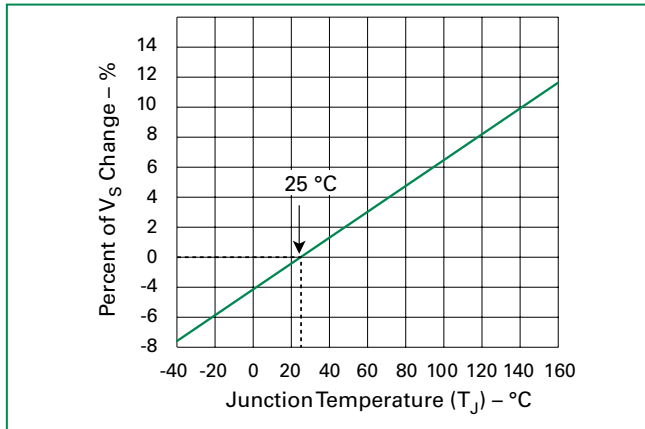
V-I Characteristics



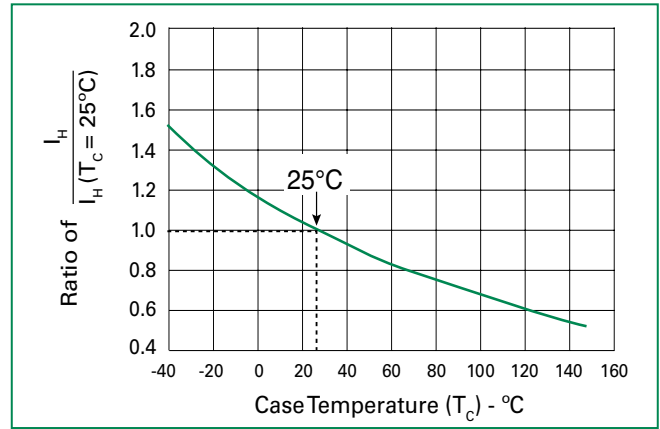
$t_r \times t_d$ Pulse Waveform



Normalized V_S Change vs. Junction Temperature

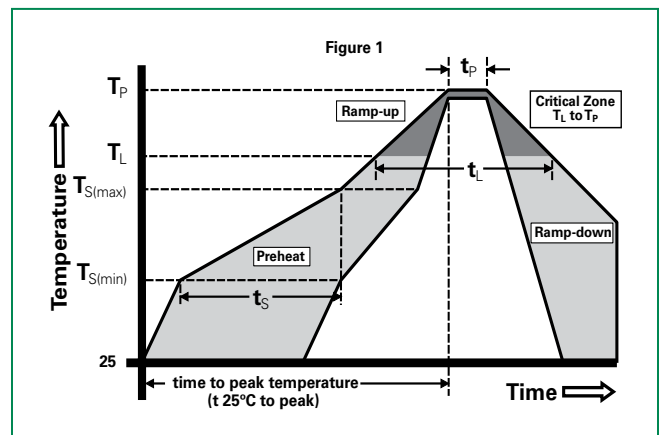


Normalized DC Holding Current vs. Case Temperature



Soldering Parameters

| | | |
|--|-----------------------------------|--------------|
| Reflow Condition | Pb-Free assembly (see Fig. 1) | |
| Pre Heat | -Temperature Min ($T_{s(min)}$) | +150°C |
| | -Temperature Max ($T_{s(max)}$) | +200°C |
| | -Time (Min to Max) (t_s) | 60-180 secs. |
| Average ramp up rate (Liquidus Temp (T_L) to peak) | 3°C/sec. Max. | |
| $T_{s(max)}$ to T_L - Ramp-up Rate | 3°C/sec. Max. | |
| Reflow | -Temperature (T_L) (Liquidus) | +217°C |
| | -Temperature (t_L) | 60-150 secs. |
| Peak Temp (T_p) | +260(+0/-5)°C | |
| Time within 5°C of actual Peak Temp (t_p) | 30 secs. Max. | |
| Ramp-down Rate | 6°C/sec. Max. | |
| Time 25°C to Peak Temp (T_p) | 8 min. Max. | |
| Do not exceed | +260°C | |



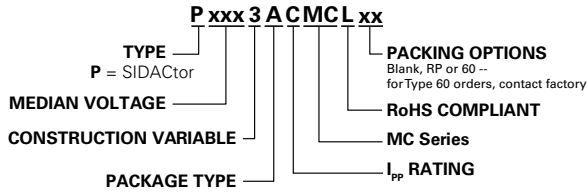
Physical Specifications

| | |
|------------------------|---|
| Lead Material | Copper Alloy |
| Terminal Finish | 100% Matte-Tin Plated |
| Body Material | UL Recognized epoxy meeting flammability classification V-0 |

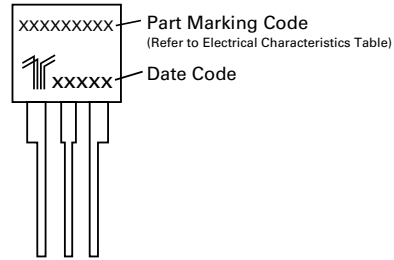
Environmental Specifications

| | |
|---|---|
| High Temp Voltage Blocking | 80% Rated V_{DRM} (V_{AC} Peak) +125°C or +150°C, 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101 |
| Temp Cycling | -65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A104 |
| Biased Temp & Humidity | 52 V_{DC} (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101 |
| High Temp Storage | +150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101 |
| Low Temp Storage | -65°C, 1008 hrs. |
| Thermal Shock | 0°C to +100°C, 5 min. dwell, 10 sec. transfer, 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106 |
| Autoclave (Pressure Cooker Test) | +121°C, 100%RH, 2atm, 24 up to 168 hrs. EIA/JEDEC, JESD22-A-102 |
| Resistance to Solder Heat | +260°C, 30 secs. MIL-STD-750 (Method 2031) |
| Moisture Sensitivity Level | 85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1 |

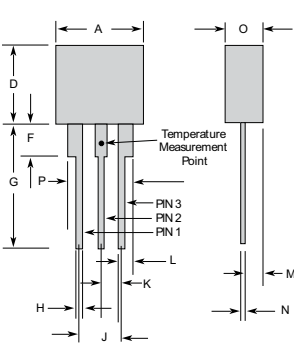
Part Numbering



Part Marking



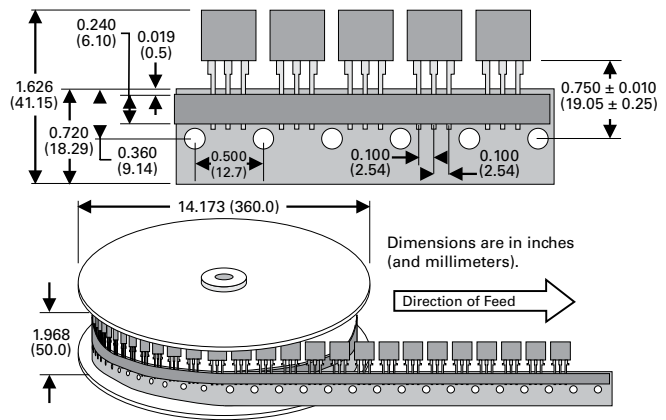
Dimensions - Modified TO-220



The modified TO-220 package is designed to meet mechanical standards as set forth in JEDEC publication number 95.

| | Inches | | Millimeters | |
|----------|--------|-------|-------------|-------|
| | Min | Max | Min | Max |
| A | 0.400 | 0.410 | 10.16 | 10.42 |
| D | 0.360 | 0.375 | 9.14 | 9.53 |
| F | 0.110 | 0.130 | 2.80 | 3.30 |
| G | 0.540 | 0.575 | 13.71 | 14.61 |
| H | 0.025 | 0.035 | 0.63 | 0.89 |
| J | 0.195 | 0.205 | 4.95 | 5.21 |
| K | 0.095 | 0.105 | 2.41 | 2.67 |
| L | 0.060 | 0.075 | 1.52 | 1.90 |
| M | 0.070 | 0.085 | 1.78 | 2.16 |
| N | 0.018 | 0.024 | 0.46 | 0.61 |
| O | 0.178 | 0.188 | 4.52 | 4.78 |
| P | 0.290 | 0.310 | 7.37 | 7.87 |

Tape and Reel Specification — Modified TO-220



Packing Options

| Package Type | Description | Quantity | Added Suffix | Industry Standard |
|--------------|--|----------|---|-------------------|
| A | Modified TO-220 Tape and Reel Pack | 700 | RP | EIA-468-B |
| | Modified TO-220 Bulk Pack | 500 | N/A | N/A |
| | Modified TO-220, Type 60 Lead Form Bulk Pack | 500 | 60 (special order item, contact factory for details) | N/A |

Additional Information



Datasheet



Resources



Samples

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